

PRIN 2020

Aggiornamento attività UR Milano Relazione Scientifica

Meeting PRIN 2020 – Bologna 2023-07-07

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Project partially founded by the Italian Ministry of University and Research, under the project PRIN2020 "Photon detection in Extreme Environments for Fundamental and Applied Physics", and by Istituto Nazionale di Fisica Nucleare (INFN) - Sezione di Milano - Italy.

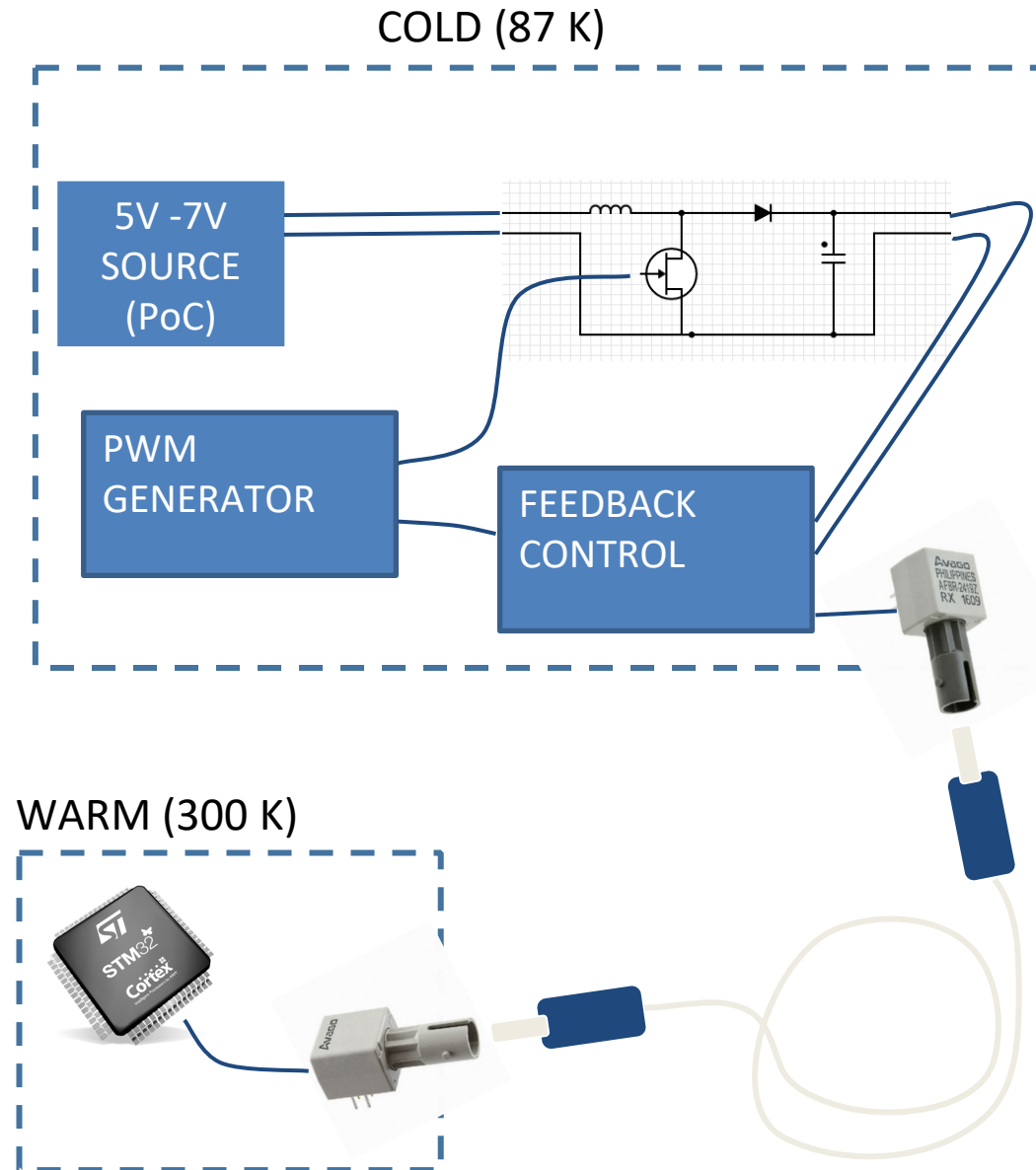


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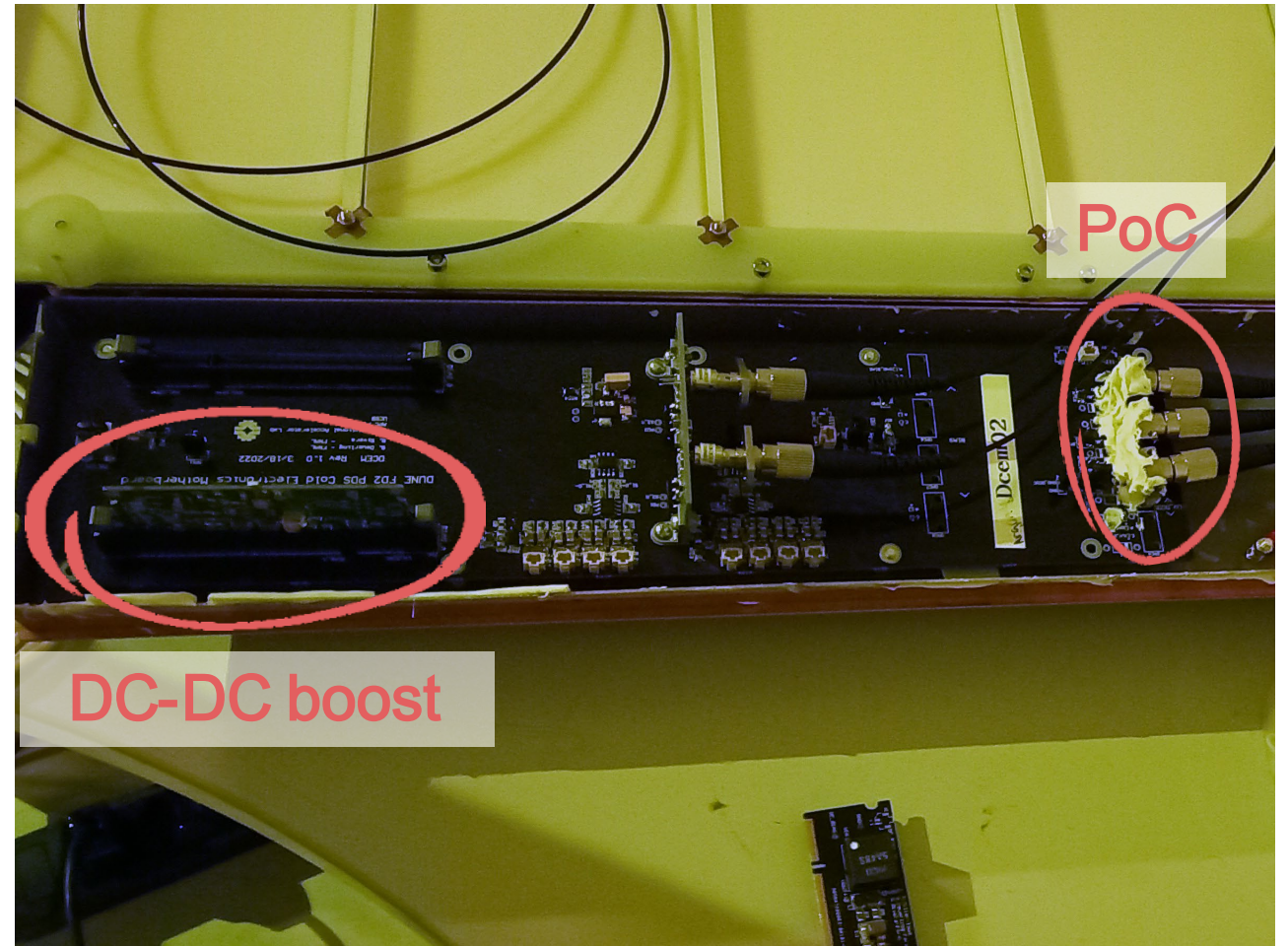
System overview

- DC-DC boost converter: HV for SiPM bias at cold
- Evolution in relation to DUNE collaboration needs
- **Power supply provided by PoC (Power optical Converter): 5 V to 7 V range**
- **Typical boost topology with MOS transistor:** output voltage up to 50 V
- **PWM generation with two possible controls:**
 - Inner feedback setting output voltage at nominal point (e.g. 48 V)
 - Optical input to change the setting voltage within few volts



Content

- GaAs Power optical Converter (PoC)
- DC-DC boost design
 - Component characterization
 - Performance
- Control design
- OpAmp characterization
- Conclusions



GaAs PoC

5 V to 7 V range power supply from PoC:

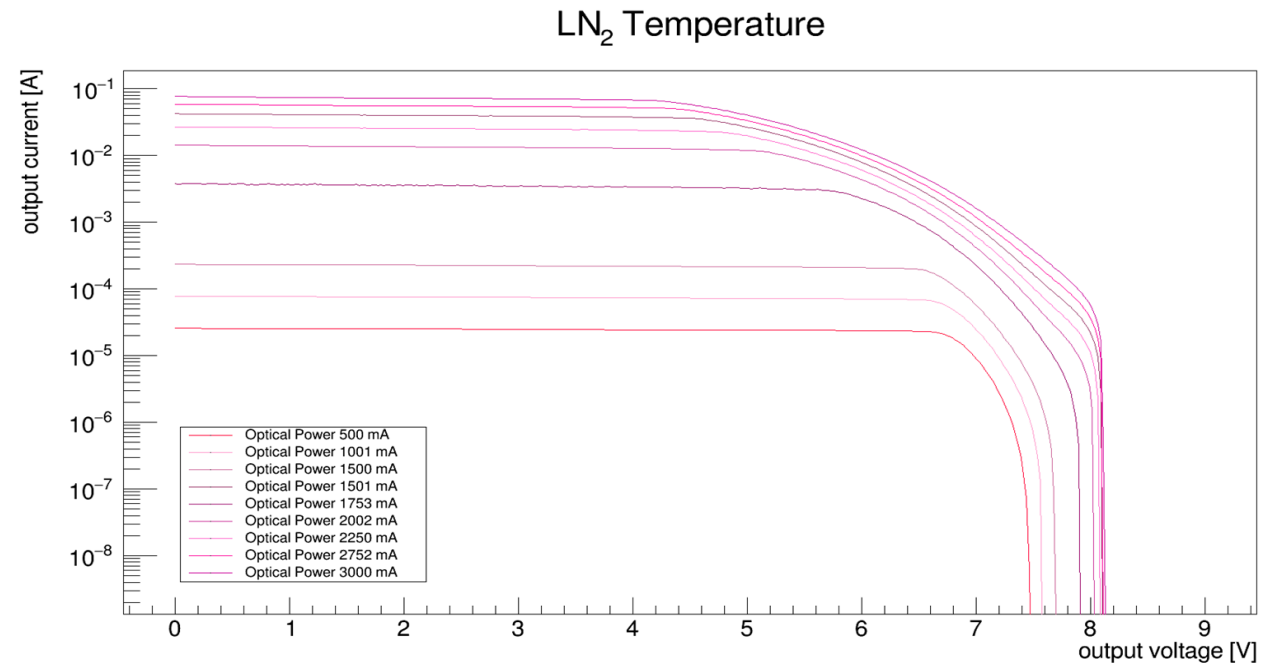
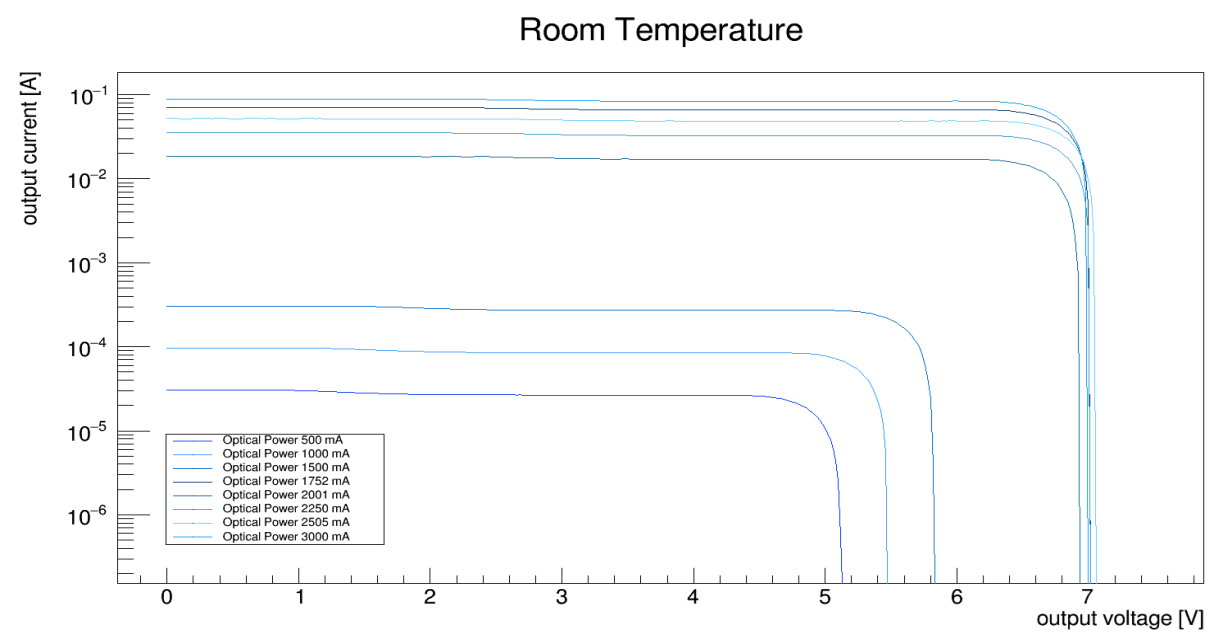
- Tests with **Broadcom AFBR-406L** based on GaAs technology
- Powered by **808 nm Lumics laser** (8 W max)
- **Multimode 200 μm core fiber**
- **B1505A Semiconductor Analyzerto** fix the output voltage and **measure the current**
- **RTD sensor** used for PoC temperature check



GaAs PoC

5 V to 7 V range power supply from PoC:

- Curves labeled according to laser input current ($P_{\text{opt}} \propto I$)
- Reference: 3 A \rightarrow 1.5 W_{opt}
- Measurements both at Room T and at LN₂ temperature
- Voltage increases from 7 V to 8 V (at 3000 mA) between Room and LN₂ temperature

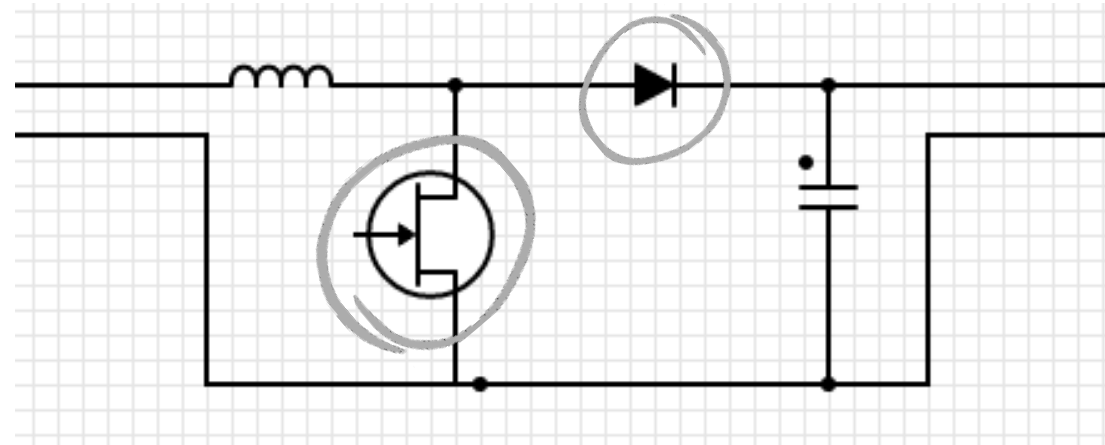


DC characterization of MOSFET and diode

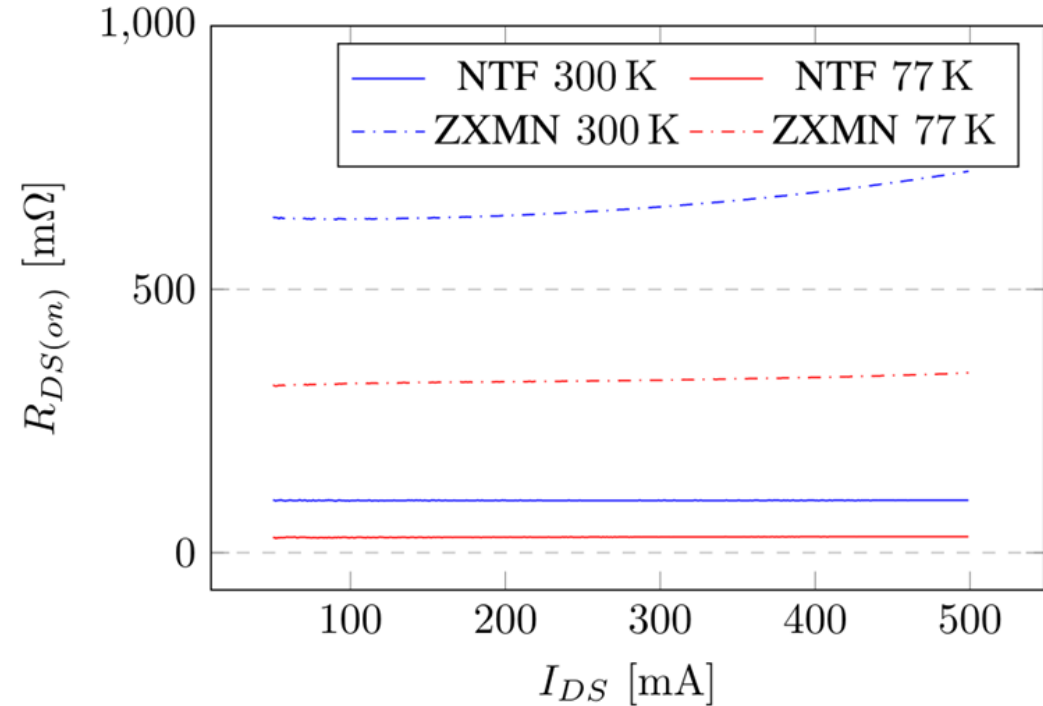
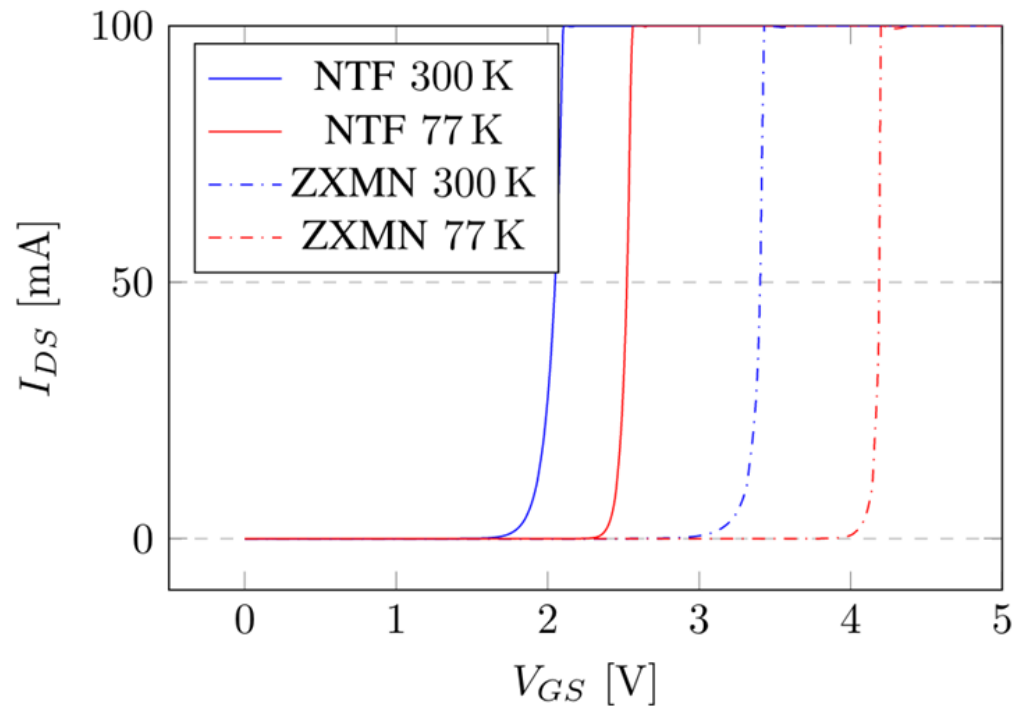
MOSFETs characterized at Room and at LN2 temperature with a B1505A Semiconductor Analyzer:

- I_D vs V_{GS} (at various V_{DS}) to measure the **threshold**
- V_{DS} vs I_D (at various V_{GS}) to measure the **on resistance** $R_{DS(on)}$

Diode forward I-V curve to measure the **junction voltage** V_D



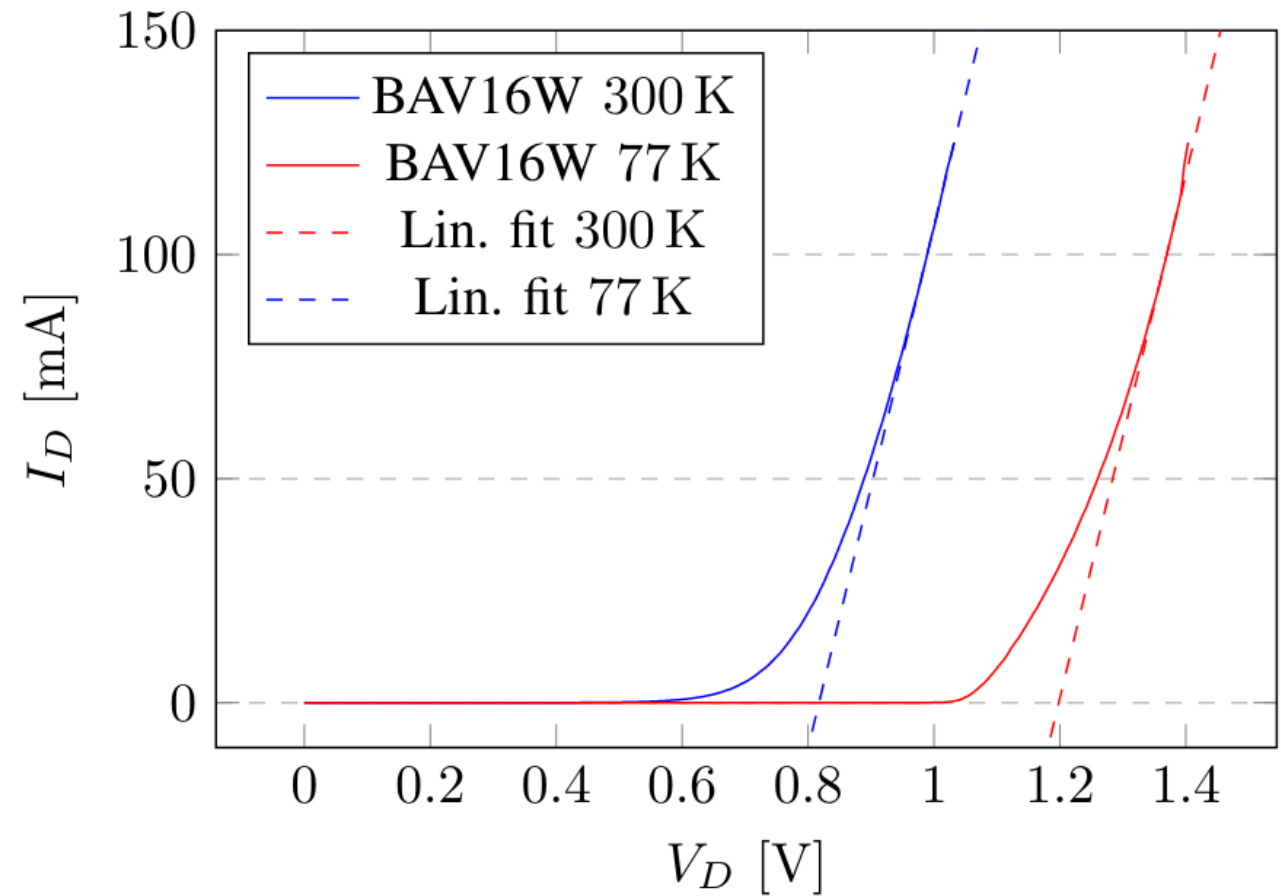
MOSFET results



- Drain current vs Gate-to-Source voltage: **threshold increases** of about 0.6 V (77 K)
- **On resistance reduces** considerably at 77 K, for NTF resulting in 30 m Ω .

Diode results

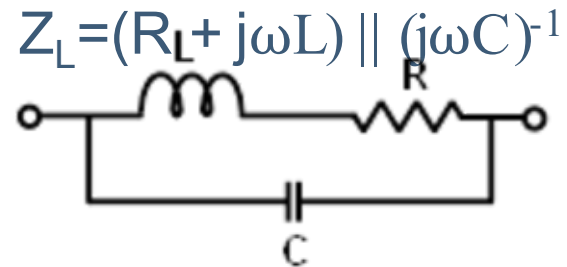
- Diode current vs applied voltage (forward bias mode): **junction voltage increase of about 0.4 V**
- Same behavior between BAV16W and BAS16LD diodes



AC characterization of inductor

- Tests on B8244T1106K05010 mH inductor
- HP 4395A Impedance Analyzer used in Reflection mode to analyze the impedance as a function of frequency

Model:



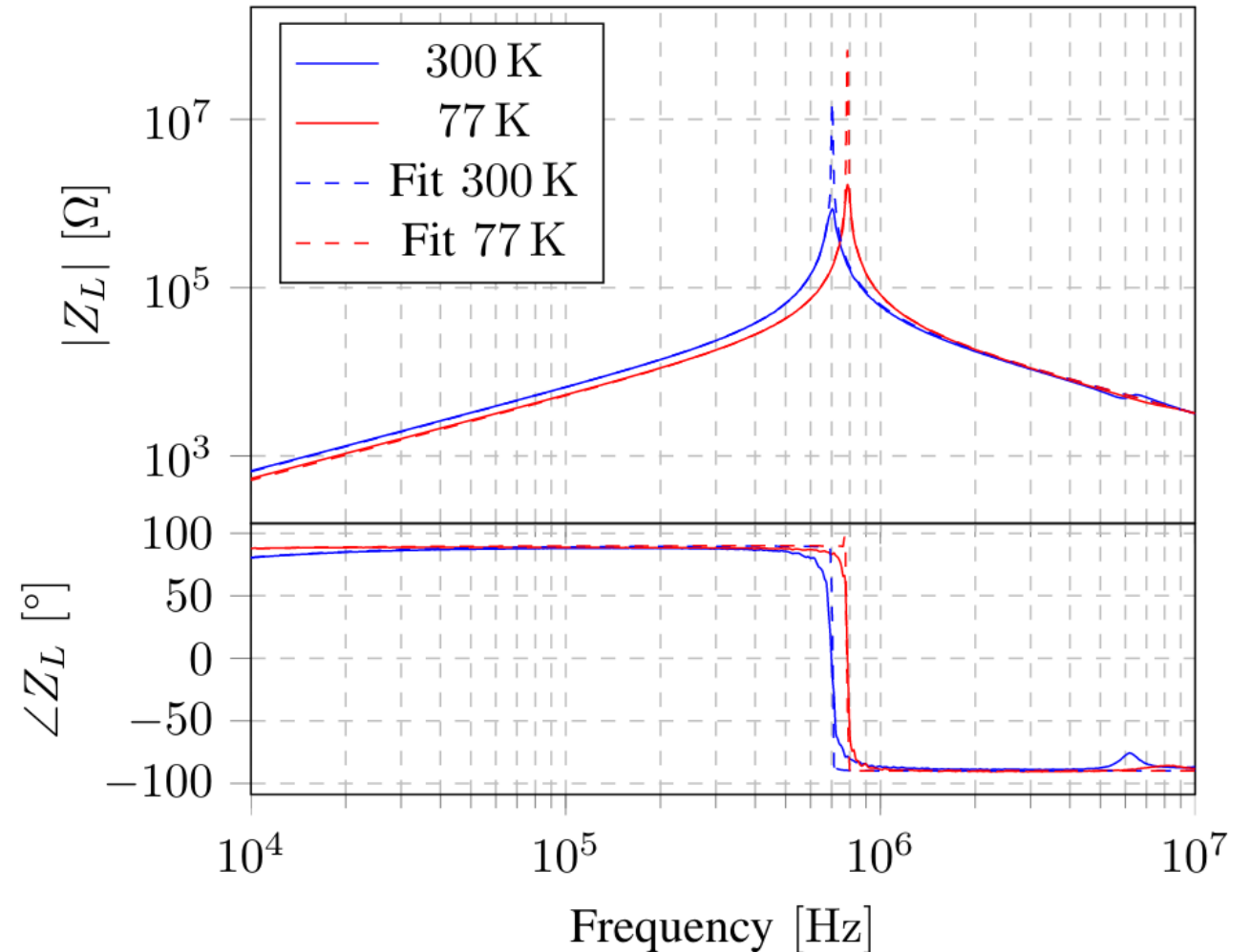
- Results fitted and parameters extracted

Inductor results

- Fitted parameters are:

T [K]	R [Ω]	L [mH]	C [pF]
300 K	106	10	5
77 K	20	8	5

- Resonance frequency is 700 kHz (800 kHz) at 300 K (77 K): good at $f_{sw} = 100$ kHz
- Series resistance drops drastically at 77 K: DC-DC converter better performances



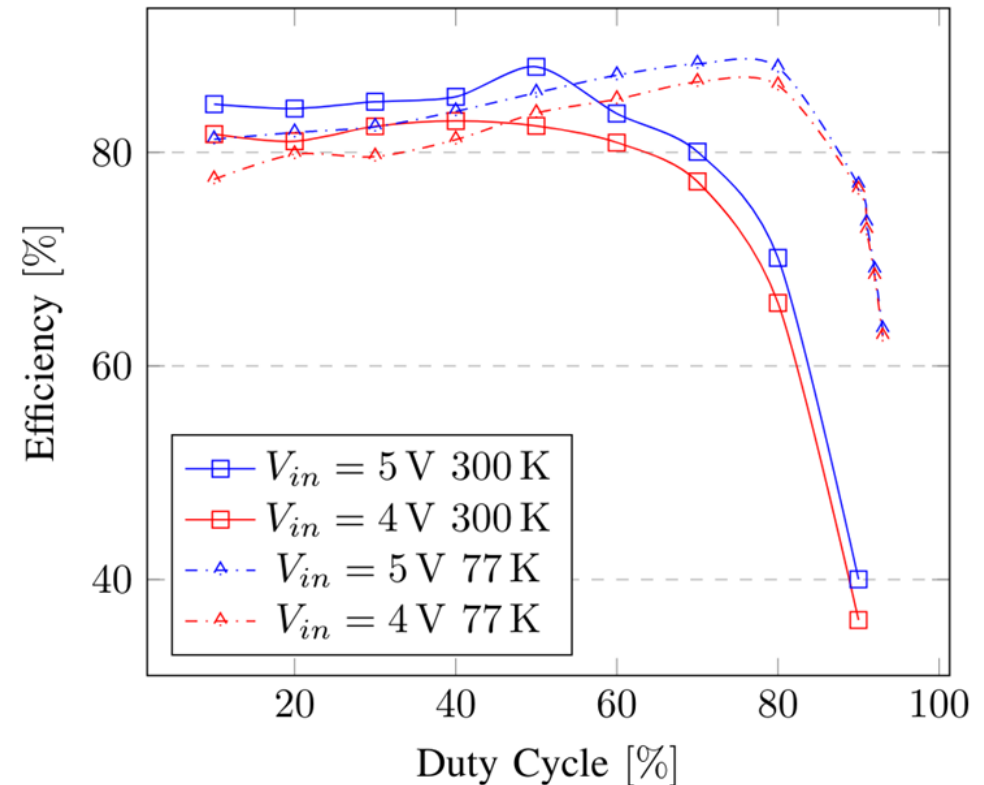
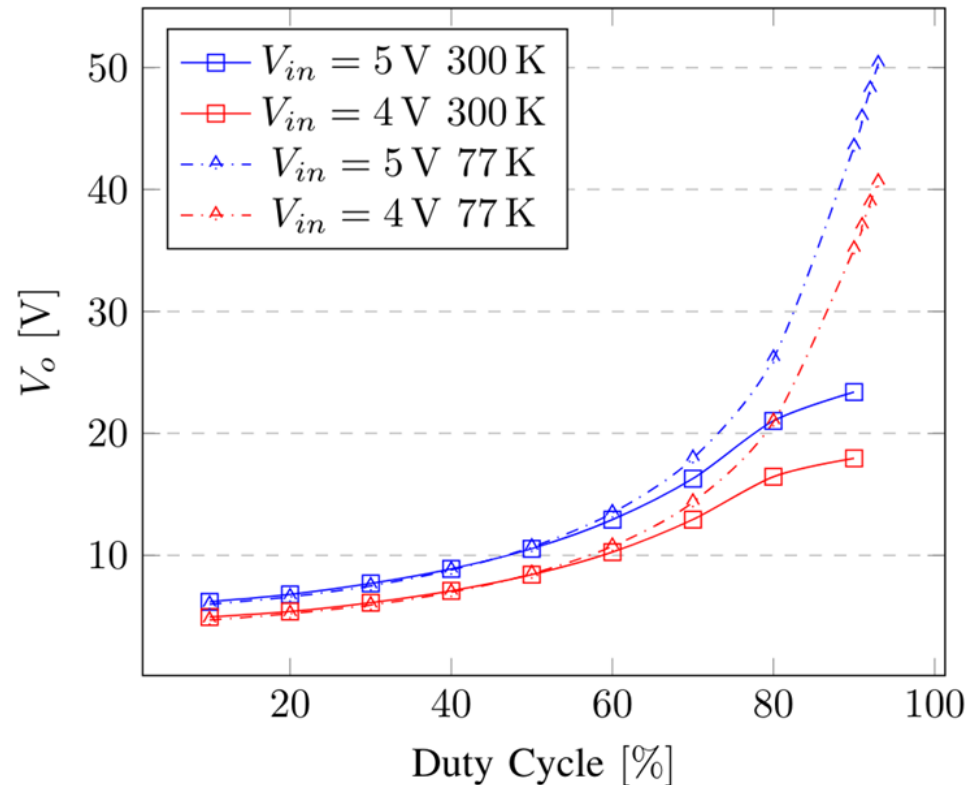
DC-DC boost converter

Components selection:

- MOSFET: *NTF3055L 108T1G, ZXMN10A07FTA, VN2460N8, 2N7002H6327XTSA2, 2N7002CK*
 - *Lowest on-resistance*
- Switching Diode: *BAV16W, BAS16LD*
 - *Very similar device, slightly better max current*
- Inductor: *B82442T1125K000 (680 μ H, 1 MHz), B8244T1106K050 (10mH, 100 kHz)*
 - *Good to mitigate input current ripple*
- Capacitor: *C1812C104J1GACTU (COG 100 nF)*
 - *COG for cryogenic use*

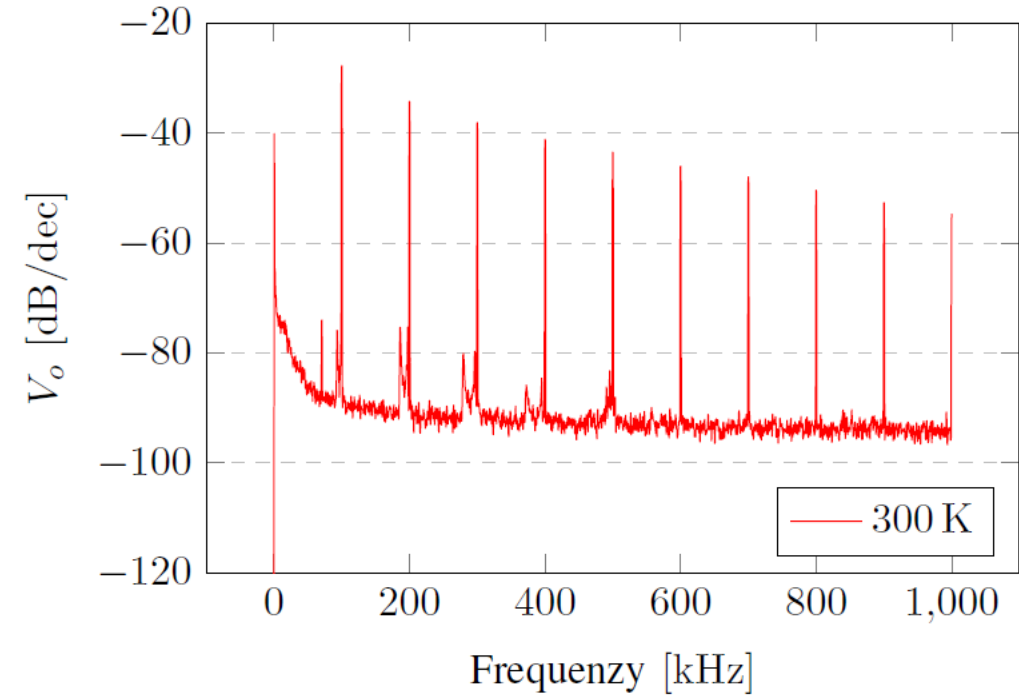
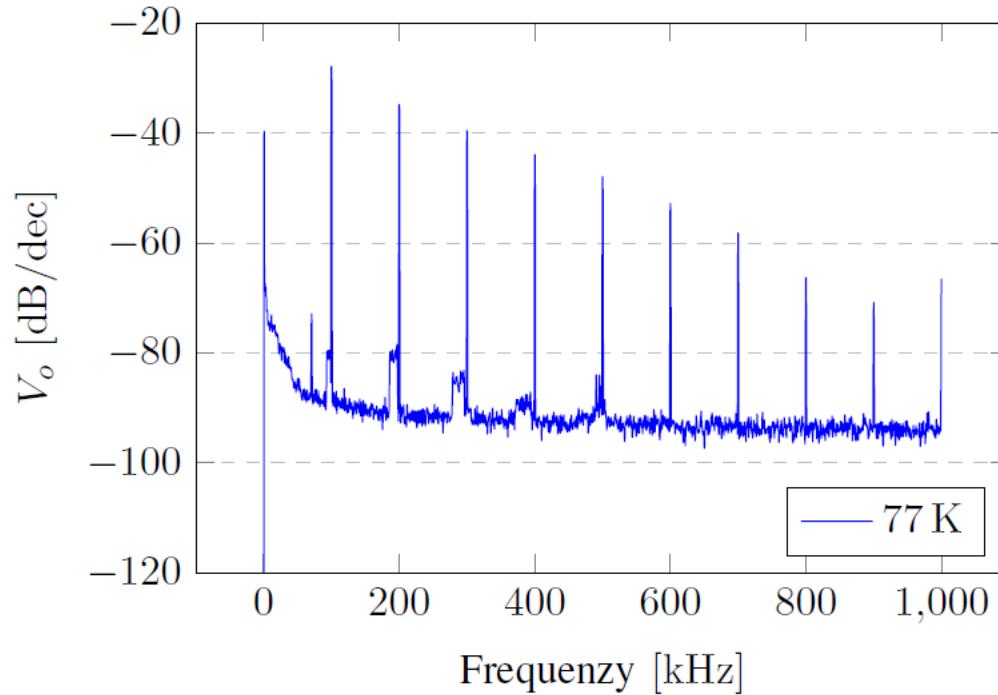
N. Gallice et al., "Development of a cryogenic DC-DC Boost Converter: devices characterization and first prototype measurements," 2022 IEEE International Instrumentation and Measurement Technology Conference (I2MTC), Ottawa, ON, Canada, 2022, pp. 1-6, doi: 10.1109/I2MTC48687.2022.9806646.

DC-DC prototype results



- **Output voltage** at RoomT limited by the inductor series resistor. At LN2 T, it is possible to reach 50 V at 93% of Duty Cycle
- The **efficiency** at LN2 is always greater than 60%

DC-DC prototype results



Submitted to TIM

- Output voltage FFT measurements at 77K (blue) and 300K (red)

Content

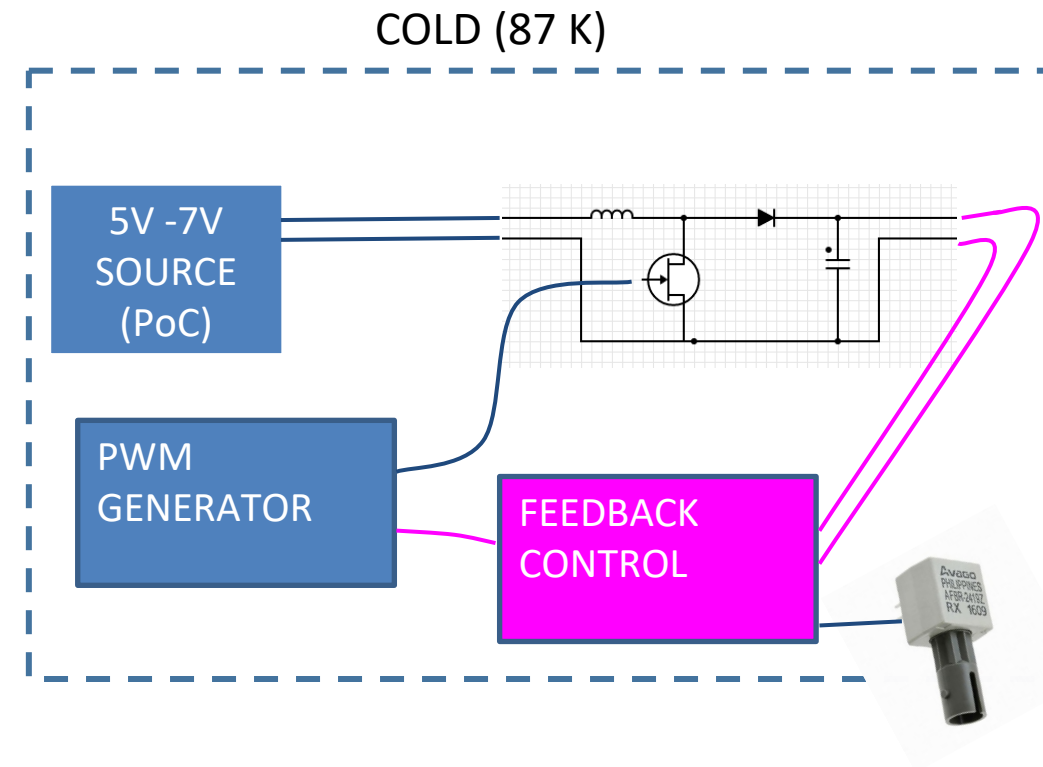
- System overview ✓
- GaAs Power optical Converter (PoC) ✓
- DC-DC boost design ✓
 - Component characterization ✓
 - Performance ✓
- Control design
- OpAmp characterization
- Conclusions

Control design

Internal feedback: output voltage control at desired set point

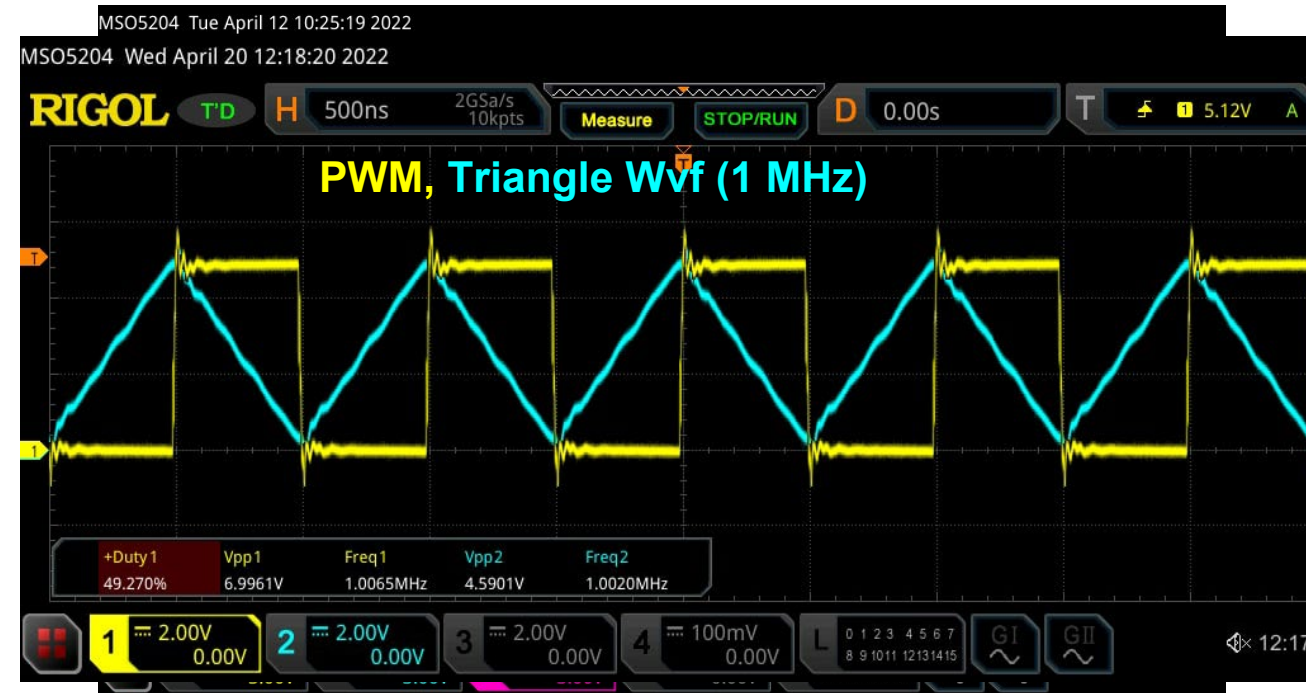
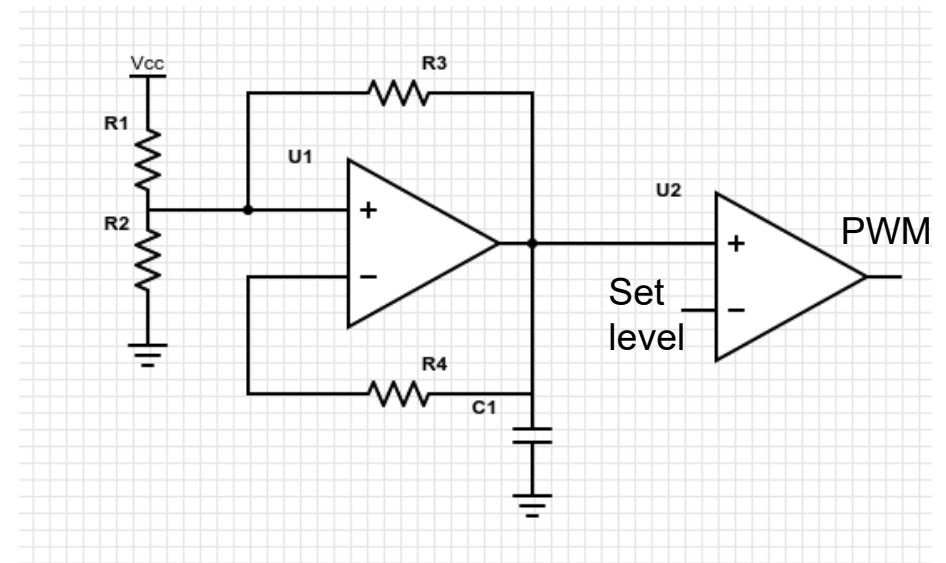
The set point can be:

- **Nominal:** set at design stage and fixed throughout the entire run (standalone mode)
- **External:** set point adjusted through external communication (in case of failure, nominal set-point)



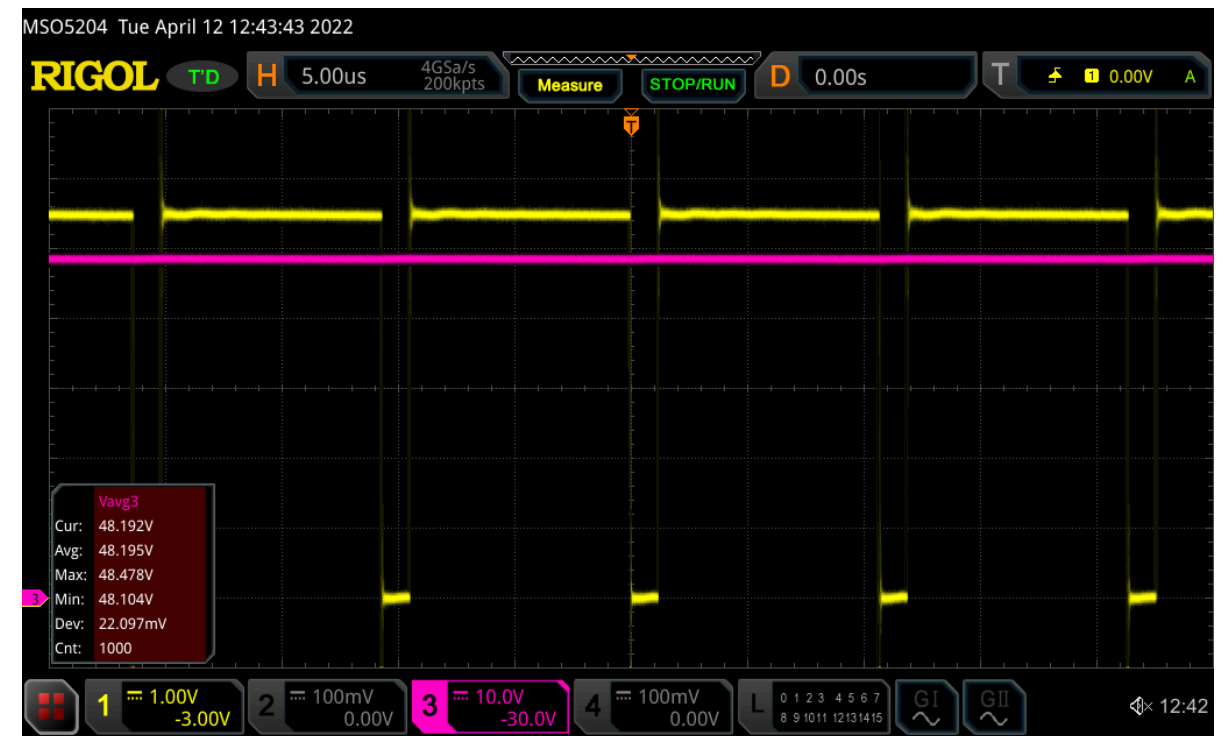
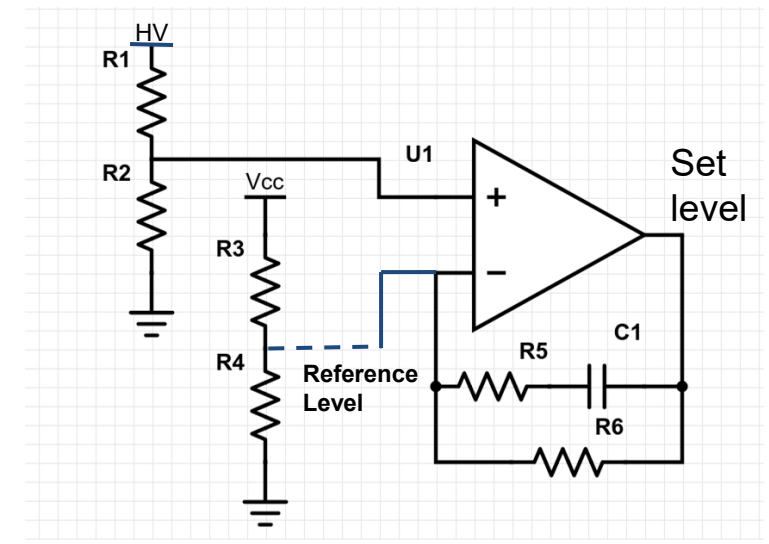
PWM generation

- PWM (Pulse Width Modulator) generation based on two comparators
- Comparators tested to work in LN₂
- First comparator set in a positive feedback circuit: oscillator
- Second comparator produces the PWM through triangle waveform (carrier) and voltage set level (modulation) inputs
- Tests at f_{sw} from ~ 100 kHz to ~ 1 MHz



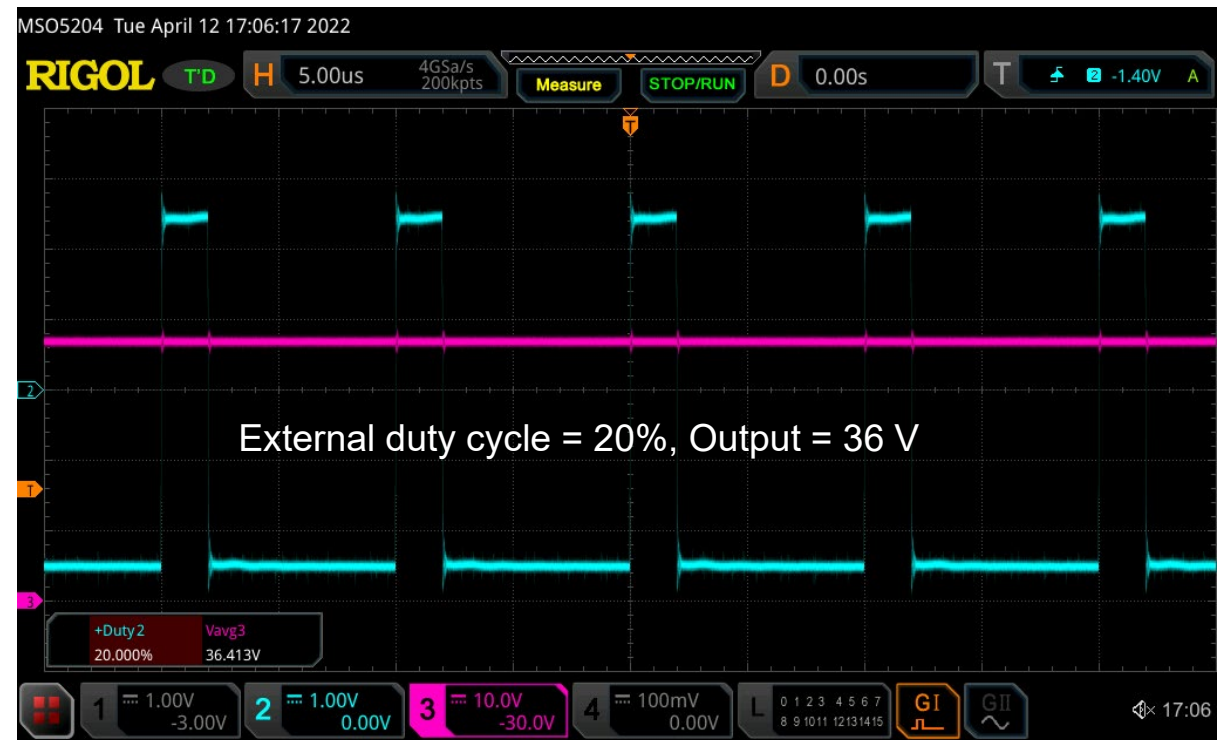
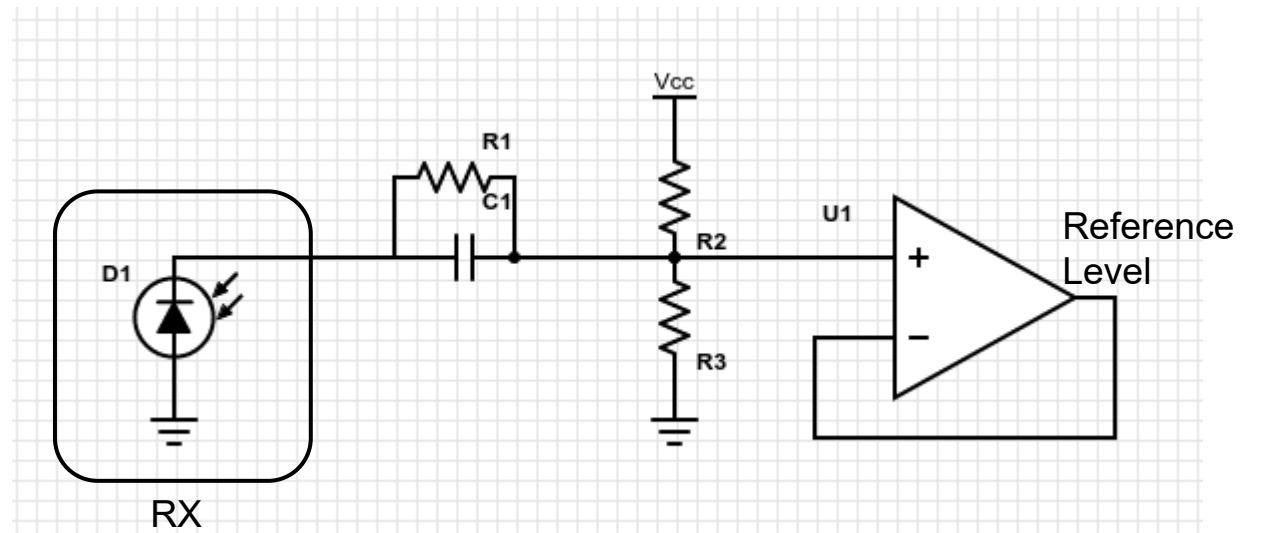
Control feedback

- Output of DC-DC boost converter compared with nominal working point (error amplifier)
- Operational amplifier tested to work in LN₂
- 48.2 V generated and kept constant by the internal feedback at LN₂ temperature (5.5 V input)
- 100 kΩ load → 485 μA
- Overall current consumption: 10.3 mA ~ 50% efficiency



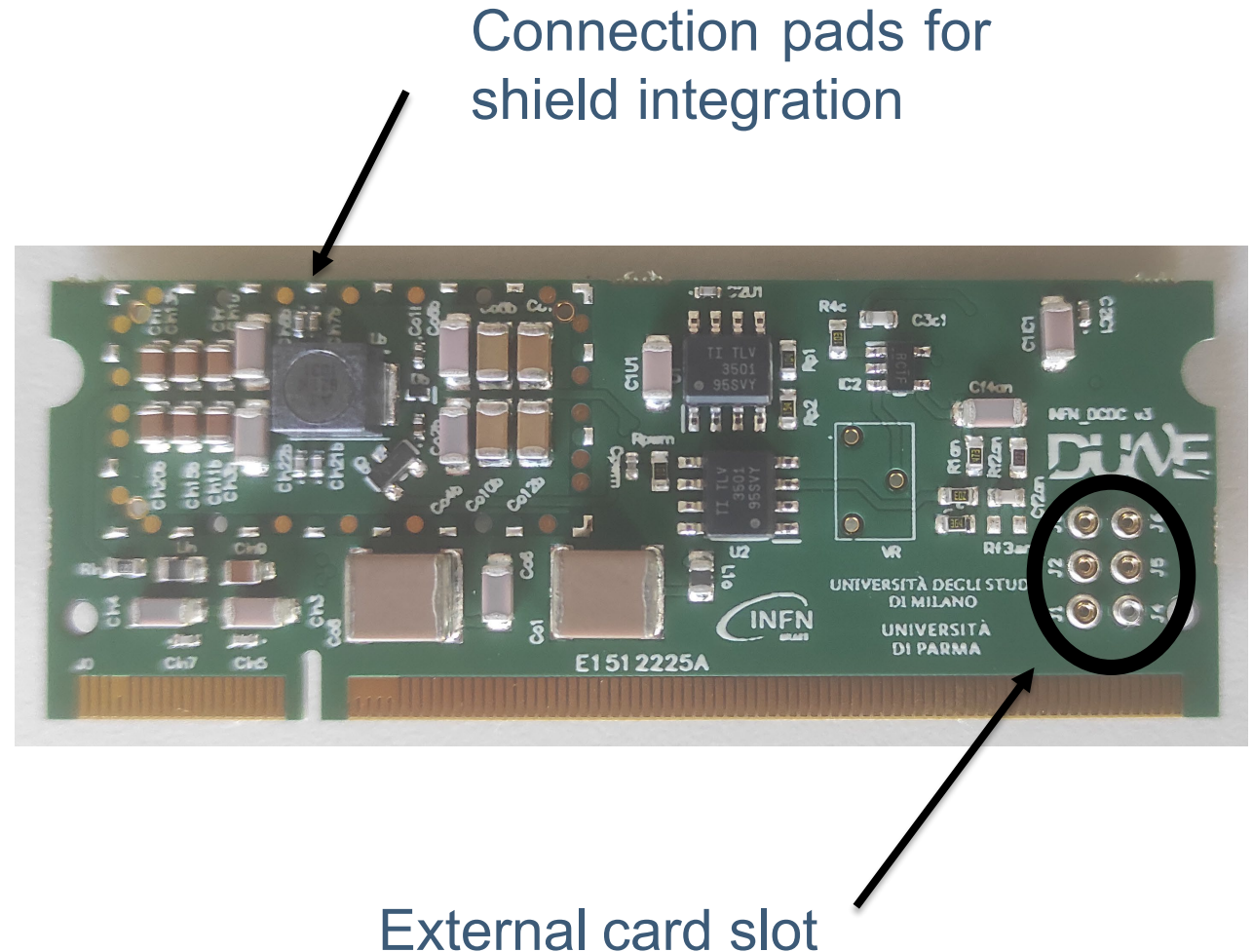
External set point

- External PWM signal drove through optical fiber: **external set point**
- Reference level changes
- AC-coupling in case of external PWM, otherwise reference set by R2-R3 divider
- E.g. with $f_{sw} \sim 100$ kHz, 5.5 V input, 20 % external duty -cycle: boost voltage output ~ 36 V (max = 51 V)



Future developments

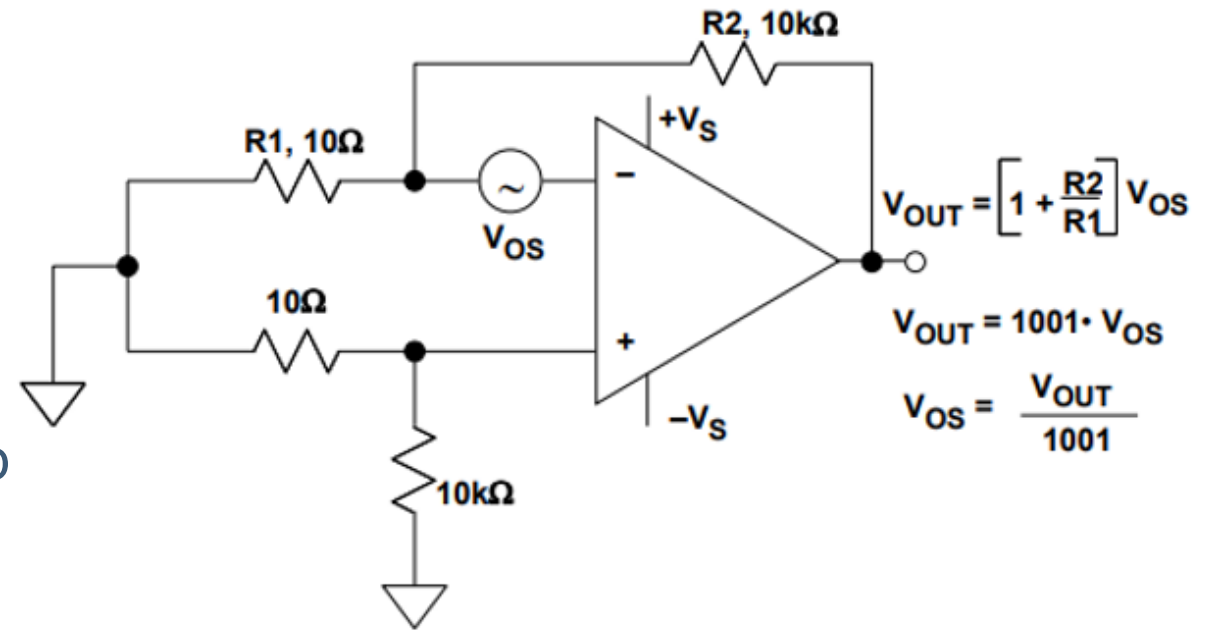
- Adding card for **external DC-DC boost converter control**
- Connection pins available on the DC-DC boost converter PCB
- **Shield integration for EMI reduction**



Component characterization: OpAmps

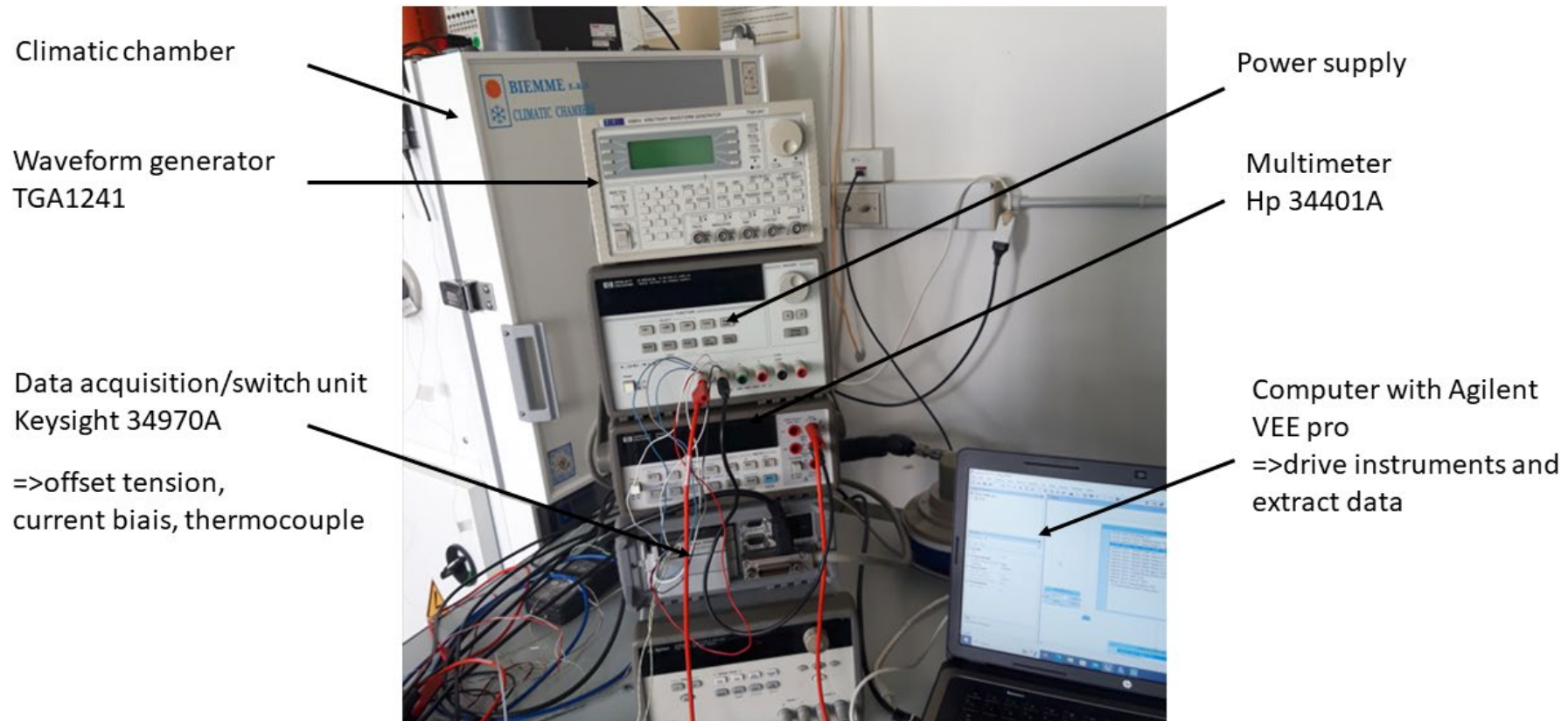
First characterization circuit for OpAmps

- DUT: OpAmp LMV321
- Input offset voltage test
- DUT in climate chamber with LN2 injection
- Offset recovery at each temperature step
- Automatic test bench control



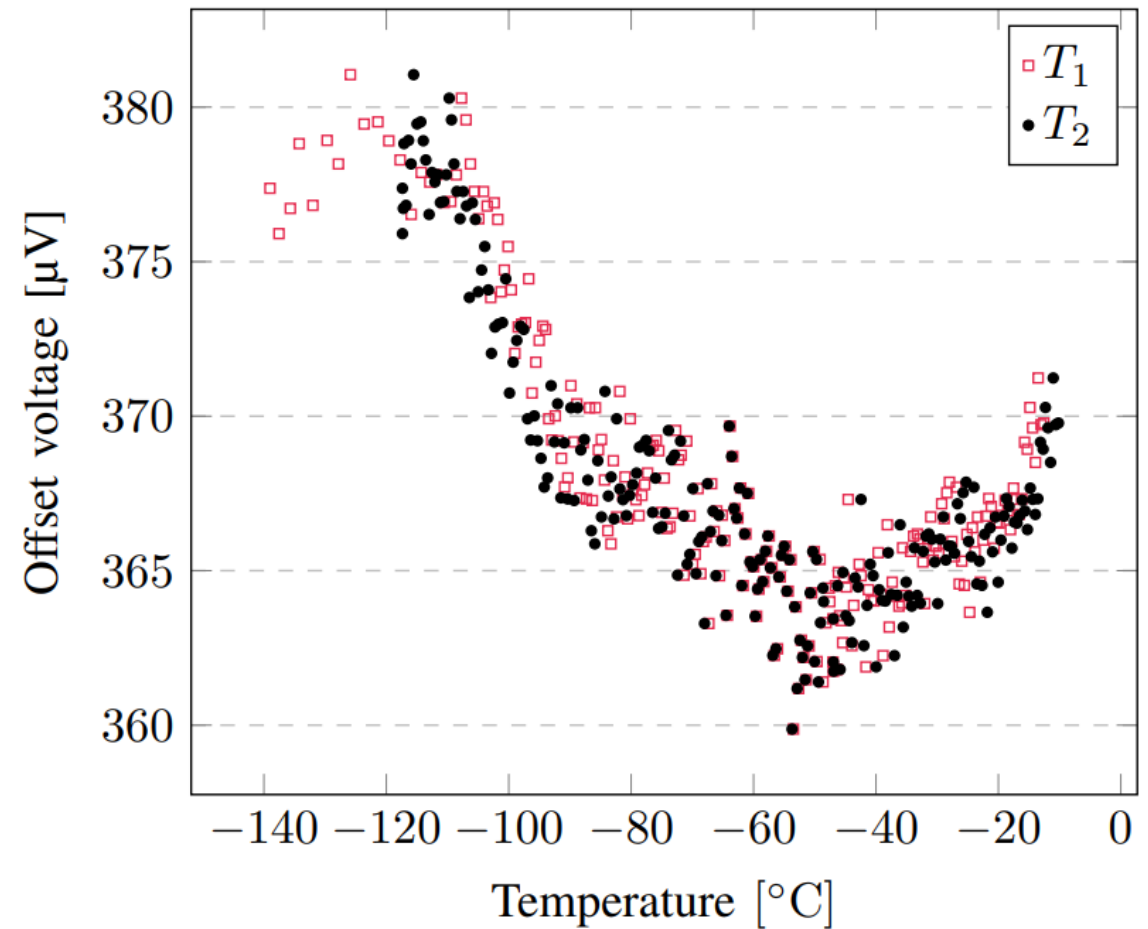
Characterization testbed

- DUT in climate chamber with LN2 injection



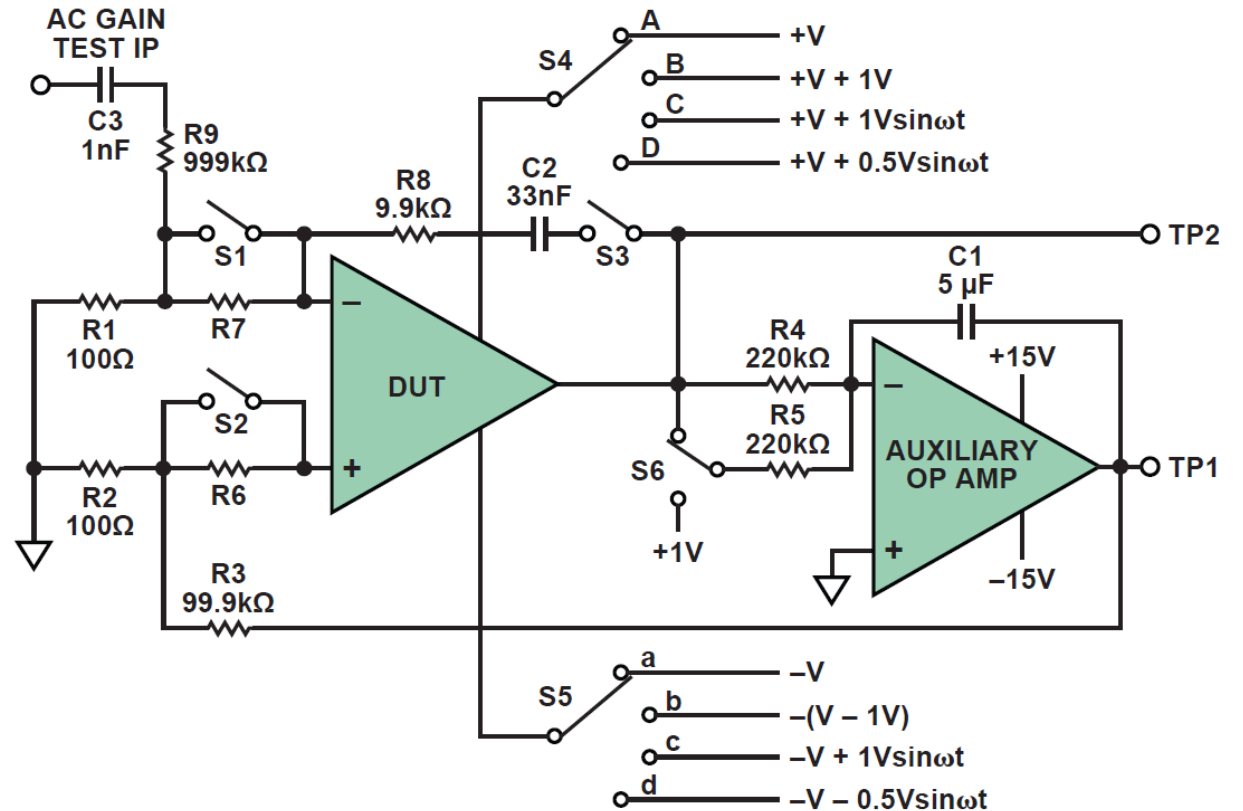
Early experimental results

- DUT: LMV321
- Temperature and input offset voltage data recovery
- Low measurement system sensibility



Revised characterization circuit

- OpAmp characterization for cyogenics:
 - Input offset voltage;
 - Bias current
 - PSRR
 - Quiescent current
- General circuit editable for all Op Amp parameters extraction
- OpAmps as DUT:
 - MCP6291
 - MCP6N11
 - LMV321
 - TLC271
 - AD8293



Future developments

- Warm test card with Auxiliary OpAmp at 300 K
- Cold test card in climate chamber with LMV321

Issues:

- Revised PCB in arrival
- Dewar with more capacity necessary
- High-rate multiplexer for data acquisition unit necessary

